

Description

The SX40P03S uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS} = -30V$ $I_D = -40A$

$R_{DS(ON)} < 4.0m\Omega$ @ $V_{GS} = -10V$

Application

Lithium battery protection

Wireless impact

Mobile phone fast charging

**Absolute Maximum Ratings (TC=25°C unless otherwise noted)**

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-30	V
V _{GS}	Gate-Source Voltage	± 20	V
I _D @TC=25°C	Continuous Drain Current, V _{GS} @ -10V1	-40	A
I _D @TC=100°C	Continuous Drain Current, V _{GS} @ -10V1	-31	A
I _{DM}	Pulsed Drain Current2	-160	A
E _{AS}	Single Pulse Avalanche Energy3	576	mJ
P _D @TC=25°C	Total Power Dissipation4	150	W
T _{TSG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C
R _{θJA}	Thermal Resistance Junction-Ambient 1	85	°C/W
R _{θJC}	Thermal Resistance Junction-Case1	1.06	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ $I_D=-250\mu\text{A}$	-30	-35		V
IDSS	Zero Gate Voltage Drain Current	$V_{DS}=-30\text{V}$, $V_{GS}=0\text{V}$			-1	μA
IGSS	Gate-Body Leakage Current	$V_{GS}=\pm20\text{V}$, $V_{DS}=0\text{V}$			±100	nA
VGS(th)	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=-250\mu\text{A}$	-1	-1.7	-2.5	V
RDS(ON)	Drain-Source On-State Resistance	$V_{GS}=-10\text{V}$, $I_D=-20\text{A}$		3.2	4.0	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}$, $I_D=-20\text{A}$		4.5	6.0	$\text{m}\Omega$
gFS	Forward Transconductance	$V_{DS}=-5\text{V}$, $I_D=-20\text{A}$		65		S
Ciss	Input Capacitance	$V_{DS}=-15\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$		7000		pF
Coss	Output Capacitance			820		pF
Crss	Reverse Transfer Capacitance			540		pF
Rg	Gate resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, $f=1.0\text{MHz}$		2.2		Ω
td(on)	Turn-on Delay Time	$V_{GS}=-10\text{V}$, $V_{DS}=-15\text{V}$, $R_L=0.75\Omega$, $R_{GEN}=3\Omega$		14		nS
t_r	Turn-on Rise Time			13		nS
td(off)	Turn-Off Delay Time			65		nS
t_f	Turn-Off Fall Time			37		nS
Qg	Total Gate Charge	$V_{GS}=-10\text{V}$, $V_{DS}=-15\text{V}$, $I_D=-20\text{A}$		130		nC
Qgs	Gate-Source Charge			12		nC
Qgd	Gate-Drain Charge			31		nC
ISD	Source-Drain Current (Body Diode)				-150	A
VSD	Forward on Voltage (Note 3)	$V_{GS}=0\text{V}$, $I_S=-20\text{A}$			-1.3	V
trr	Reverse Recovery Time	$I_F=-20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		30		ns
Qrr	Reverse Recovery Charge	$I_F=-20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		40		nC

Note :

- 1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3、The EAS data shows Max. rating . The test condition is $T_J =25^\circ\text{C}$, $VDD=-15\text{V}$, $VG=-10\text{V}$, $RG=25\Omega$, $L=0.5\text{mH}$, $IAS=-30\text{A}$
- 4、The power dissipation is limited by 150°C junction temperature
- 5、The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

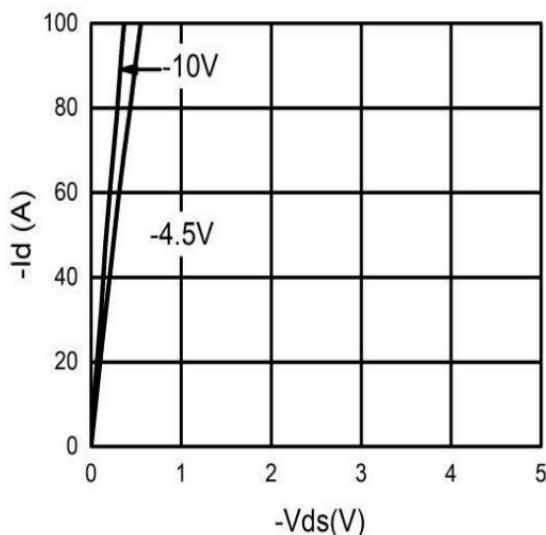


Figure 1. Output Characteristics

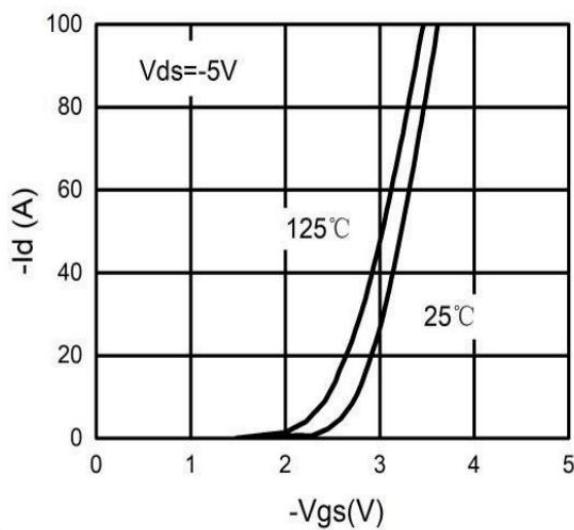


Figure 2. Transfer Characteristics

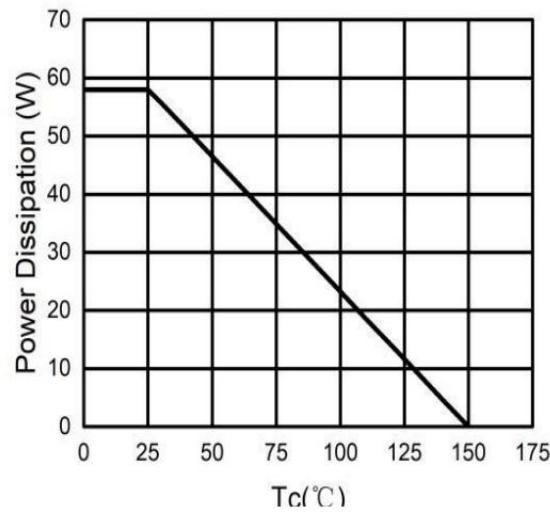


Figure 3. Power Dissipation

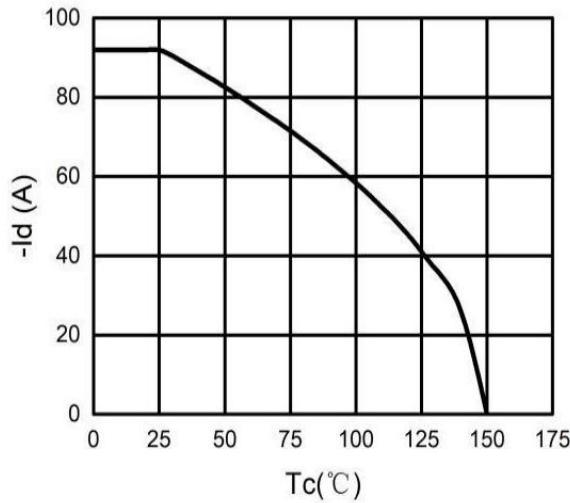


Figure 4. Drain Current

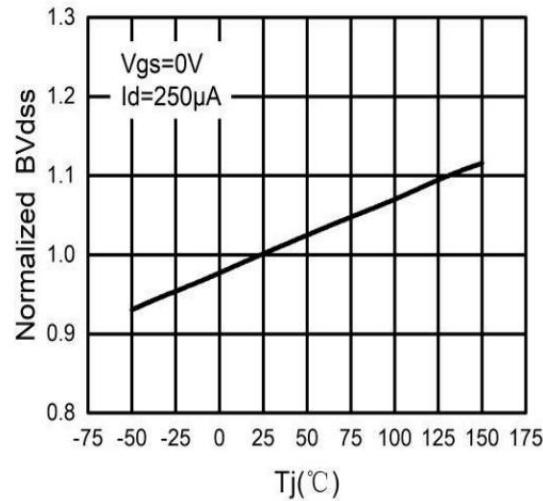


Figure 5. BV_{dss} vs Junction Temperature

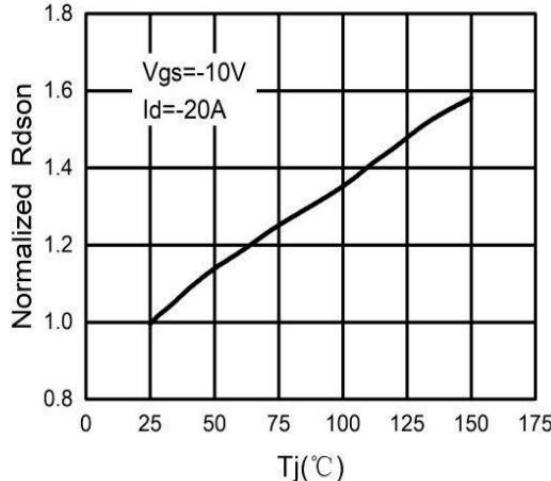
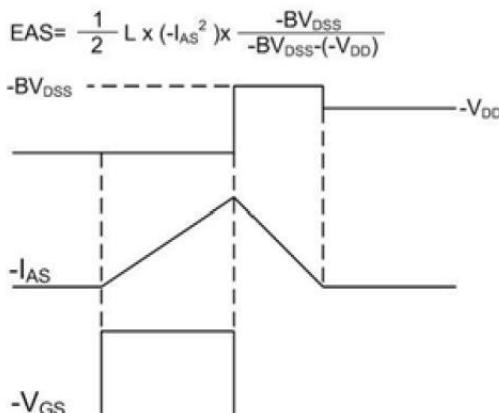
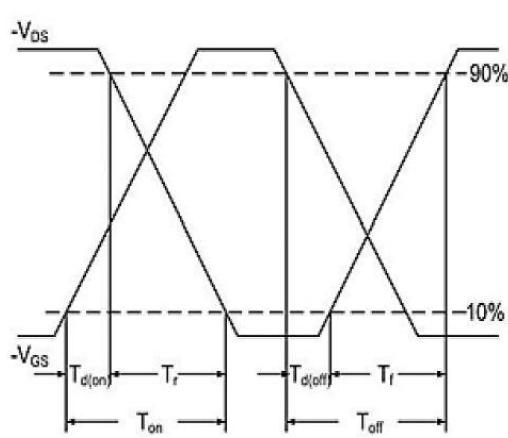
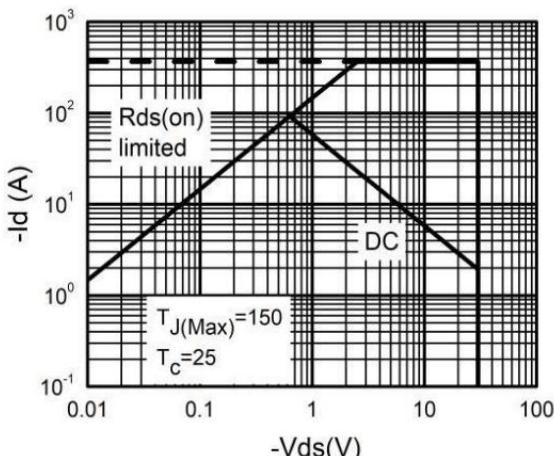
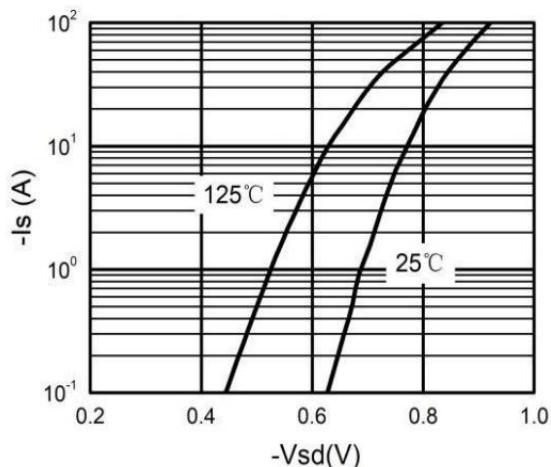
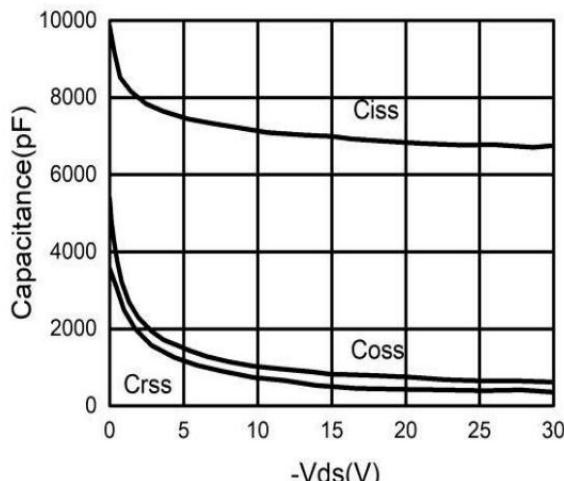
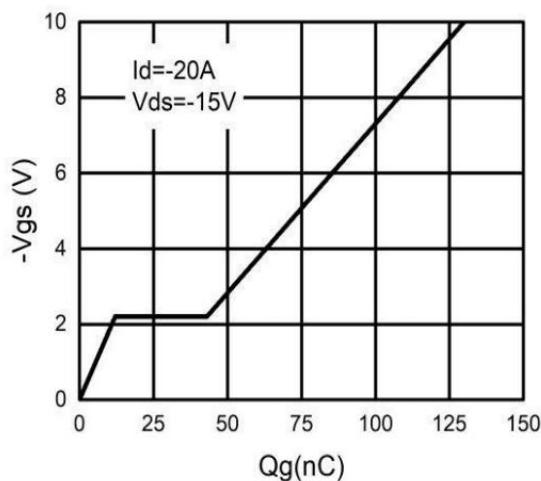
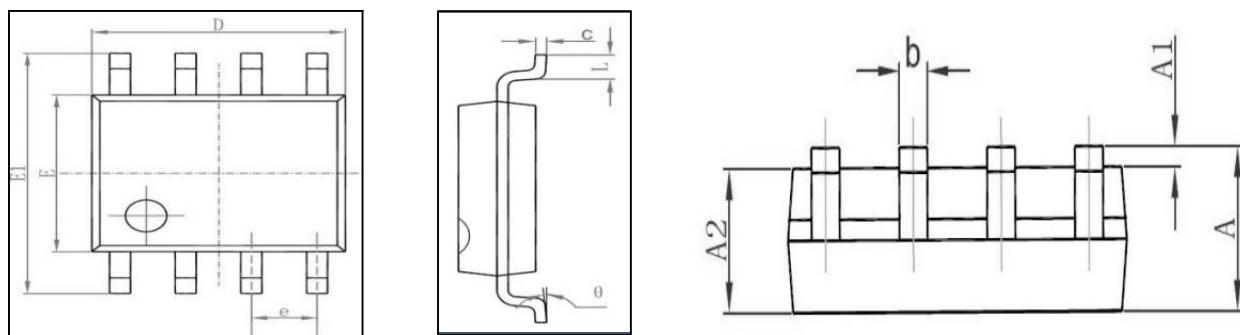


Figure 6. $R_{DS(on)}$ vs Junction Temperature

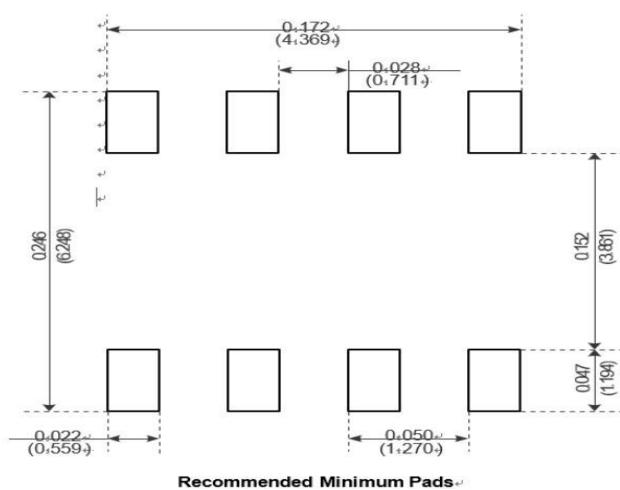
Typical Characteristics



Package Mechanical Data-SOP-8L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
TAPING	SOP-8L		3000